

PACKAGING SPECIFICATION

1.25MM PITCH WIRE TO BOARD R/A CONN.

1.0 SCOPE

THIS PRODUCT SPECIFICATION COVERS THE 1.25MM WIRE TO BOARD CONNECTOR.10P

(본 제품 사양서는 1.25MM WIRE TO BOARD CONN.10P 에 대하여 규정한다)

2.0 PRODUCT DESCRIPTION 제품 번호(PART NUMBER):

포장	전 제품 번호	포장 후 제품 번호		
(BEFO	RE PACKING)	(AFTER PACKING)		
10P	104091-1020	104091-1020		

3.0 표준 포장 수량(PACKING QUANTITY)

CKT	EMBOSS TAPE			DEEL		CARTON BOX	
	CARRIER		TOP	REEL		ENG. NO. 35909-0082	
	WIDT		TNC No	FNG N-	O'TV	REEL	Q'TY
	Н	ENG. No.	ENG. No.	ENG. No.	Q'TY	Q'TY	(TOTAL)
10	32	104091-9902	35902-1011	35908-1013	1,500	4	6,000

4.0 라벨 사양(LABEL SPECIFICATION)

CKT	Current Rating	Voltage Rating	해외인증
10	1.5A Max.	200 Wax	

THIS DOCUMENT CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION. REVISION: **EC INFORMATION:** TITLE: SHEET No 1.25MM WIRE TO BOARD CONN. EC No: 632260 (104091 SERIES) PACKAGING SPECIFICATION. DATE: DOCUMENT NUMBER: CREATED / REVISED BY: APPROVED BY: CHECKED BY: PS 002 PK-104091-001 **VLOKESHA** TEMPLATE FILENAME: PACKAGING_SPEC[SIZE_A] (V.4).DOCX



molex PACKAGING SPECIFICATION

5.0 NOTE

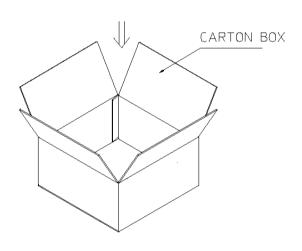
- 포장 평가는 ES40000-7001에 따르고, LEVELII 기준 1을 적용한다 (ESTIMATE: APPLIED TO ES-40000-7001 AND LEVEL II, CRITERION 1)

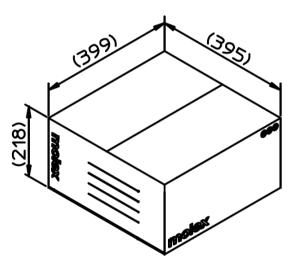
6.0 PROCEDURE

- PACKING INSTRUCTIONS : 해당 BOX에 PACKING 된 REEL을 넣고 포장한다.

[Packing Process]







[Packing Completion]

PENDING APPROVAL

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REVISION:	EC INFORMATION:	TITLE:				SHEET N
	EC No: 632260			25MM WIRE TO B		
C1	DATE:	(1040	91 S	ERIES) PACKAG	ING SPECIFIC	ATION. 2 of 2
DOCUMENT NUMBER:		DOC TYPE:	<u>DOC</u> PART:	CREATED / REVISED BY:	CHECKED BY:	APPROVED BY:
PK-104091-001 PS 002 VLOKESHA						
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